

# **Description**

The SQ7415AEN uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

### **General Features**

 $V_{DS} = -60V I_{D} = -20A$ 

 $R_{DS(ON)}$  < 65 m $\Omega$  @  $V_{GS}$ =4.5V

### **Application**

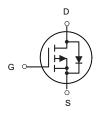
Battery protection

Load switch

Uninterruptible power supply

# D D S S S S Pin 1

DFN3X3-8L (PowerPAK1212-8)



P-Channel MOSFET

### **Package Marking and Ordering Information**

Product ID	Pack	Brand	Qty(PCS)
SQ7415AEN	DFN3X3-8L (PowerPAK1212-8)	HXY MOSFET	5000

### Absolute Maximum Ratings (T<sub>c</sub>=25<sup>°</sup>Cunless otherwise noted)

Symbol	Parameter Rating		Units
VDS	Drain-Source Voltage	-60	V
VGS	Gate-Source Voltage	±20	V
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	-20	А
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	-12	А
IDM	Pulsed Drain Current <sup>2</sup>	-30	А
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation⁴	25	W
TSTG	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
ReJA	Thermal Resistance Junction-ambient <sup>1</sup>	62	°C/W
R <sub>θ</sub> JC	Thermal Resistance Junction-Case <sup>1</sup>	5	°C/W



## Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ =0V , $I_D$ =-250uA	-60			V
$\triangle BV_{DSS}/\triangle T_{J}$	BV <sub>DSS</sub> Temperature Coefficient	Reference to 25°C , I <sub>D</sub> =-1mA		-0.023		V/°C
В	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =-10V , I <sub>D</sub> =-10A		55	65	mΩ
R <sub>DS(ON)</sub>		$V_{GS}$ =-4.5V , $I_D$ =-6A		83	90	
$V_{GS(th)}$	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> . In =-250uA	-1.2		-2.5	V
$\triangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	V <sub>GS</sub> -V <sub>DS</sub> , I <sub>D</sub> 250uA		4		mV/°C
ı	Drain Source Lookage Current	V <sub>DS</sub> =-24V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			-1	uA
I <sub>DSS</sub>	Drain-Source Leakage Current	$V_{DS}$ =-24V , $V_{GS}$ =0V , $T_J$ =55 $^{\circ}$ C			-5	
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}$ = $\pm 20V$ , $V_{DS}$ = $0V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =-5V , I <sub>D</sub> =-15A		12		S
Qg	Total Gate Charge (-4.5V)			6.1		
$Q_{gs}$	Gate-Source Charge	V <sub>DS</sub> =-15V , V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-15A		3.1		nC
$Q_{gd}$	Gate-Drain Charge			1.8		
T <sub>d(on)</sub>	Turn-On Delay Time			2.6		
T <sub>r</sub>	Rise Time	$V_{DD}$ =-15V , $V_{GS}$ =-10V , $R_{G}$ =3.3 $\Omega$ ,		8.6		no
T <sub>d(off)</sub>	Turn-Off Delay Time	I <sub>D</sub> =-15A		33.6		ns
T <sub>f</sub>	Fall Time			6		
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =-15V , V <sub>GS</sub> =0V , f=1MHz		585		
Coss	Output Capacitance			100		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			85		

### **Diode Characteristics**

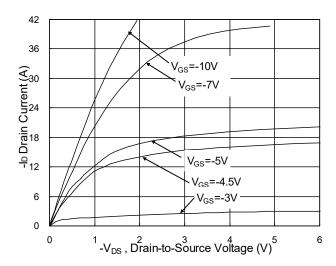
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current <sup>1,5</sup>	V =V =0V Force Current		-	-20	Α
I <sub>SM</sub>	Pulsed Source Current <sup>2,5</sup>	$V_G=V_D=0V$ , Force Current			-30	Α
$V_{SD}$	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =-1A , T <sub>J</sub> =25°C			-1.2	V
t <sub>rr</sub>	Reverse Recovery Time	lr=-15A , dl/dt=100A/μs ,		6.1		nS
Q <sub>rr</sub>	Reverse Recovery Charge	T <sub>J</sub> =25°C		1.4		nC

### Note

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%
- 3. The EAS data shows Max. rating . The test condition is  $V_{DD}$ =-25V, $V_{GS}$ =-10V,L=0.1mH, $I_{AS}$ =-19A
- 4.The power dissipation is limited by 150°C junction temperature
- 5. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



# **Typical Characteristics**



**Fig.1 Typical Output Characteristics** 

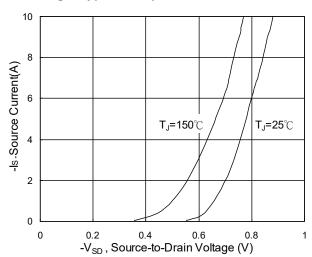


Fig.3 Forward Characteristics Of Reverse

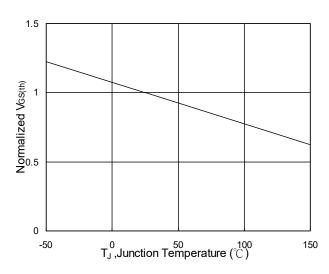


Fig.5 Normalized  $V_{\text{GS(th)}}$  vs.  $T_J$ 

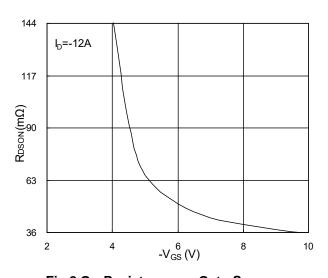


Fig.2 On-Resistance v.s Gate-Source

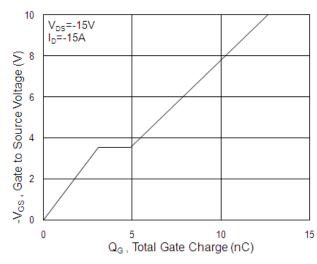


Fig.4 Gate Charge Characteristics

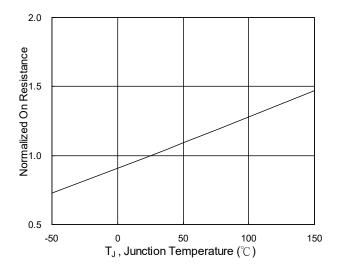
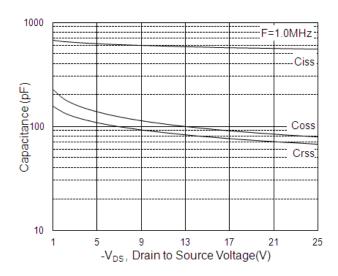


Fig.6 Normalized  $R_{\text{DSON}}$  vs.  $T_{\text{J}}$ 





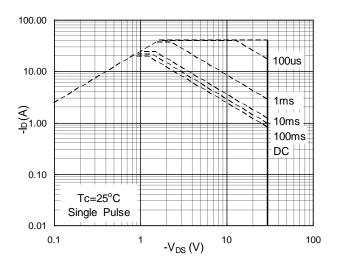


Fig.7 Capacitance

Fig.8 Safe Operating Area

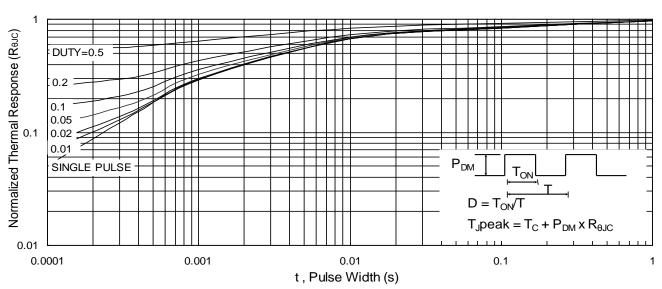


Fig.9 Normalized Maximum Transient Thermal Impedance

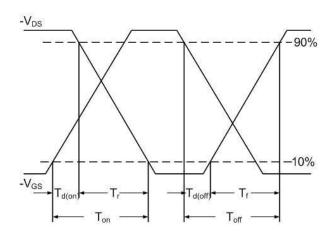


Fig.10 Switching Time Waveform

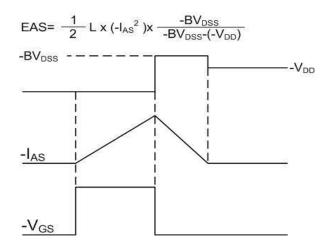
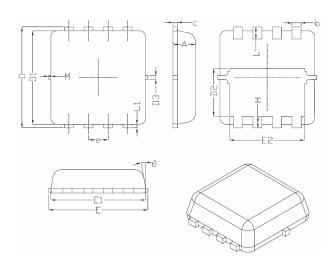


Fig.11 Unclamped Inductive Switching Waveform



# DFN3X3-8L(PowerPAK1212-8) Package Information



Complete I	Dimensions In Millimeters			
Symbol	Min.	Nom.	Max.	
A	0.70	0.75	0.80	
b	0.25	0.30	0.35	
С	0.10	0.15	0.25	
D	3.25	3.35	3.45	
D1	3.00	3.10	3.20	
D2	1.48	1.58	1.68	
D3	-	0.13	-	
E	3.20	3.30	3.40	
E1	3.00	3.15	3.20	
E2	2.39	2.49	2.59	
е	0.65BSC			
Н	0.30	0.39	0.50	
L	0.30	0.40	0.50	
L1	-	0.13	-	
M	*	*	0.15	
θ		10 <sup>°</sup>	12 <sup>°</sup>	



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